# onsemi

The NL27WZ16 is a high performance dual buffer operating from a 1.65 V to 5.5 V Supply.

# Features

- Designed for 1.65 V to 5.5 V  $V_{CC}$  Operation
- 2.4 ns  $t_{PD}$  at  $V_{CC} = 5 V (Typ)$
- Inputs/Outputs Overvoltage Tolerant up to 5.5 V
- I<sub>OFF</sub> Supports Partial Power Down Protection
- Sink 32 mA at 4.5 V
- Available in SC-88, SC-74 and UDFN6 Packages
- Chip Complexity < 100 FETs
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

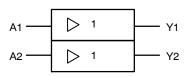


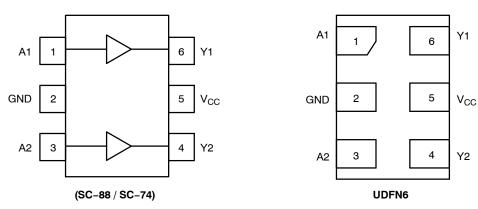
Figure 1. Logic Symbol

DATA SHEET www.onsemi.com

|          |  | MARKING<br>DIAGRAMS                |
|----------|--|------------------------------------|
|          | SC-88<br>DF SUFFIX<br>CASE 419B-02                       | 6        <br>  XXXM-<br>  0 -<br>1 |
| <b>S</b> | SC-74<br>CASE 318F-05                                    | 1                                  |
| ¢        | UDFN6<br>1.2x1.0, 0.4P<br>CASE 517AA                     | × M<br>●                           |
| ٢        | UDFN6<br>1.45x1.0, 0.5P<br>CASE 517AQ                    | ◆ XM                               |
| ۲        | UDFN6<br>1x1, 0.35P<br>CASE 517BX                        | 1 • X M                            |
| M        | XXX = Specific Device<br>= Date Code*<br>= Pb-Free Packa | ge                                 |
| ,        | : Microdot may be in eit                                 | ,                                  |
| ^Date Co | de orientation and/or p<br>ing upon manufacturing        | osition may vary<br>location.      |

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

# NL27WZ16





### **PIN ASSIGNMENT**

| Pin | Function        |
|-----|-----------------|
| 1   | A1              |
| 2   | GND             |
| 3   | A2              |
| 4   | Y2              |
| 5   | V <sub>CC</sub> |
| 6   | Y1              |

# FUNCTION TABLE

| A Input | Y Output |
|---------|----------|
| L       | L        |
| Н       | н        |

## MAXIMUM RATINGS

| Symbol                              | Characteristics                                 | Value   | Units  |      |
|-------------------------------------|---|---|--|------|
| V <sub>CC</sub>                     | DC Supply Voltage                               |   | -0.5 to +6.5   | V    |
| V <sub>IN</sub>                     | DC Input Voltage                                |   | –0.5 to +6.5   | V    |
| V <sub>OUT</sub>                    | DC Output Voltage<br>SC-88, SC-74, UDFN6        | Active-Mode (High or Low State)<br>Tri-State Mode (Note 1)<br>Power-Down Mode (V <sub>CC</sub> = 0 V) | $\begin{array}{c} -0.5 \text{ to } V_{CC} + 0.5 \\ -0.5 \text{ to } + 6.5 \\ -0.5 \text{ to } + 6.5 \end{array}$ | V    |
| I <sub>IK</sub>                     | DC Input Diode Current, V <sub>IN</sub> < GND   |   | -50  | mA   |
| I <sub>ОК</sub>                     | DC Output Diode Current, V <sub>OUT</sub> < GND |   | -50  | mA   |
| I <sub>OUT</sub>                    | DC Output Source/Sink Current                   |   | ±50  | mA   |
| $I_{\rm CC}  {\rm or}  I_{\rm GND}$ | DC Supply Current per Supply Pin or Ground Pin  |   | ±100   | mA   |
| T <sub>STG</sub>                    | Storage Temperature Range                       |   | –65 to +150  | °C   |
| ΤL                                  | Lead Temperature, 1 mm from Case for 10 secs    |   | 260  | °C   |
| TJ                                  | Junction Temperature under Bias                 |   | +150   | °C   |
| $\theta_{JA}$                       | Thermal Resistance (Note 2)                     | SC-88<br>SC-74<br>UDFN6   | 377<br>320<br>154  | °C/W |
| PD                                  | Power Dissipation in Still Air                  | SC-88<br>SC-74<br>UDFN6   | 332<br>390<br>812  | mW   |
| MSL                                 | Moisture Sensitivity                            |   | Level 1  | -    |
| F <sub>R</sub>                      | Flamebility Rating                              | Oxygen Index: 28 to 34  | UL 94-V-0 @ 0.125 in   | -    |
| V <sub>ESD</sub>                    | ESD Withstand Voltage (Note 3)                  | Human Body Model<br>Charged Device Model<br>(NLV) Charged Device Model                                | 2000<br>1000<br>N/A  | V    |
| ILATCHUP                            | Latchup Performance (Note 4)                    |   | ±100   | mA   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.Applicable to devices with outputs that may be tri-stated.

 Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow per JESD51-7.
 HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115-A (Machine Model) be discontinued per JEDEC/JEP172A.

4. Tested to EIA/JESD78 Class II.

## **RECOMMENDED OPERATING CONDITIONS**

| Symbol                          | Para                               | Min   | Max              | Unit                          |      |
|---------------------------------|------------------------------------|---|------------------|-------------------------------|------|
| V <sub>CC</sub>                 | Positive DC Supply Voltage         |   | 1.65             | 5.5                           | V    |
| V <sub>IN</sub>                 | DC Input Voltage                   |   | 0                | 5.5                           | V    |
| V <sub>OUT</sub>                | DC Output Voltage                  | Active-Mode (High or Low State)<br>Tri-State Mode (Note 1)<br>Power-Down Mode (V <sub>CC</sub> = 0 V)   | 0<br>0<br>0      | V <sub>CC</sub><br>5.5<br>5.5 | V    |
| T <sub>A</sub>                  | Operating Temperature Range        |   | -55              | +125                          | °C   |
| t <sub>r</sub> , t <sub>f</sub> | Input Transition Rise or Fall Rate | $\begin{array}{l} V_{CC} = 1.65 \ V \ to \ 1.95 \ V \\ V_{CC} = 2.3 \ V \ to \ 2.7 \ V \\ V_{CC} = 3.0 \ V \ to \ 3.6 \ V \\ V_{CC} = 4.5 \ V \ to \ 5.5 \ V \end{array}$ | 0<br>0<br>0<br>0 | 20<br>20<br>10<br>5           | ns/V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

# DC ELECTRICAL CHARACTERISTICS

|                  |                              |   | Vcc  | Τ <sub>4</sub>   | T <sub>A</sub> = 25°C                                     |  |  | A ≤ 125°C                                 |       |
|------------------|------------------------------|---|--|--|---|--|--|---|-------|
| Symbol           | Parameter                    | Condition   | (V)  | Min  | Тур   | Max  | Min  | Max                                       | Units |
| VIH              | High-Level Input             |   | 1.65 to 1.95   | 0.65 x V <sub>CC</sub>   |   |  | $0.65 \times V_{CC}$   |   | V     |
|                  | Voltage                      |   | 2.3 to 5.5   | 0.70 x V <sub>CC</sub>   |   |  | $0.70 \times V_{CC}$   |   |       |
| VIL              | Low-Level Input              |   | 1.65 to 1.95   |  |   | 0.35 x V <sub>CC</sub>                           |  | 0.35 x V <sub>CC</sub>                    | V     |
|                  | Voltage                      |   | 2.3 to 5.5   |  |   | $0.30 \times V_{CC}$                             |  | 0.30 x V <sub>CC</sub>                    |       |
| V <sub>OH</sub>  | High-Level Output<br>Voltage | $ \begin{array}{l} V_{IN} = V_{IH} \text{ or } V_{IL} \\ I_{OH} = -100 \ \mu A \\ I_{OH} = -4 \ m A \\ I_{OH} = -8 \ m A \\ I_{OH} = -12 \ m A \\ I_{OH} = -16 \ m A \\ I_{OH} = -24 \ m A \\ I_{OH} = -32 \ m A \end{array} $                                    | 1.65 to 5.5<br>1.65<br>2.3<br>2.7<br>3.0<br>3.0<br>4.5 | V <sub>CC</sub> - 0.1<br>1.29<br>1.9<br>2.2<br>2.4<br>2.3<br>3.8 | V <sub>CC</sub><br>1.4<br>2.1<br>2.4<br>2.7<br>2.5<br>4.0 |  | V <sub>CC</sub> - 0.1<br>1.29<br>1.9<br>2.2<br>2.4<br>2.3<br>3.8 |   | V     |
| V <sub>OL</sub>  | Low-Level Output<br>Voltage  | $ \begin{array}{l} V_{IN} = V_{IH} \text{ or } V_{IL} \\ I_{OL} = 100 \ \mu\text{A} \\ I_{OL} = 4 \ m\text{A} \\ I_{OL} = 8 \ m\text{A} \\ I_{OL} = 12 \ m\text{A} \\ I_{OL} = 16 \ m\text{A} \\ I_{OL} = 24 \ m\text{A} \\ I_{OL} = 32 \ m\text{A} \end{array} $ | 1.65 to 5.5<br>1.65<br>2.3<br>2.7<br>3.0<br>3.0<br>4.5 |  | -<br>0.08<br>0.2<br>0.22<br>0.28<br>0.38<br>0.42          | 0.1<br>0.24<br>0.3<br>0.4<br>0.4<br>0.55<br>0.55 |  | 0.1<br>0.24<br>0.3<br>0.4<br>0.55<br>0.55 | V     |
| I <sub>IN</sub>  | Input Leakage Current        | $V_{IN}$ = 5.5 V or GND   | 1.65 to 5.5  | -  | -   | ±0.1   | -  | ±1.0                                      | μA    |
| I <sub>OFF</sub> | Power Off Leakage<br>Current | V <sub>IN</sub> = 5.5 V or<br>V <sub>OUT</sub> = 5.5 V  | 0  | -  | -   | 1.0  | -  | 10  | μA    |
| I <sub>CC</sub>  | Quiescent Supply<br>Current  | $V_{IN} = V_{CC}$ or GND  | 5.5  | -  | -   | 1.0  | -  | 10  | μΑ    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

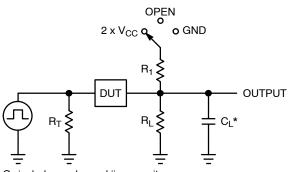
# AC ELECTRICAL CHARACTERISTICS

|  |   |              |                     | Г   | G <sub>A</sub> = 25°C | )   | –40°C ≤ 1 | Γ <sub>A</sub> ≤ 85°C | –55°C ≤ T | A ≤ 125°C |      |
|--|---|--------------|---------------------|-----|-----------------------|-----|-----------|-----------------------|-----------|-----------|------|
| Symbol   | Parameter   | Condition    | V <sub>CC</sub> (V) | Min | Тур                   | Max | Min       | Max                   | Min       | Max       | Unit |
| t <sub>PLH</sub> , Propagation<br>t <sub>PHL</sub> Delay, A to Y | $RL = 1 M\Omega$ ,<br>CL = 15 pF  | 1.65 to 1.95 | -                   | 8.0 | 9.6                   | -   | 10.2      | -                     | 10.2      | ns        |      |
|  | (Figures 3 and 4)<br>$\begin{array}{c} RL = 1 \ M\Omega, \\ CL = 15 \ pF \end{array}$ $\begin{array}{c} RL = 500 \ \Omega, \\ CL = 50 \ pF \end{array}$ |              | 2.3 to 2.7          | -   | 3.0                   | 5.2 | -         | 5.8                   | -         | 5.8       |      |
|  |   | 3.0 to 3.6   | -                   | 2.3 | 3.6                   | -   | 4.0       | -                     | 4.0       |           |      |
|  |   |              | 4.5 to 5.5          | -   | 1.8                   | 2.9 | -         | 3.2                   | -         | 3.2       |      |
|  |   | · · ·        | 3.0 to 3.6          | -   | 3.0                   | 4.6 | -         | 5.1                   | -         | 5.1       |      |
|  |   | UL = 50 pF   | 4.5 to 5.5          | -   | 2.4                   | 3.8 | -         | 4.2                   | -         | 4.2       |      |

# CAPACITIVE CHARACTERISTICS

| Symbol           | Parameter                              | Condition   | Typical    | Unit |
|------------------|--|---|------------|------|
| C <sub>IN</sub>  | Input Capacitance                      | $V_{CC}$ = 5.5 V, $V_{I}$ = 0 V or $V_{CC}$   | 2.5        | pF   |
| C <sub>OUT</sub> | Output Capacitance                     | $V_{CC}$ = 5.5 V, $V_{I}$ = 0 V or $V_{CC}$   | 4.0        | pF   |
| C <sub>PD</sub>  | Power Dissipation Capacitance (Note 5) | 10 MHz, $V_{CC}$ = 3.3 V, $V_{IN}$ = 0 V or $V_{CC}$ 10 MHz, $V_{CC}$ = 5.0 V, $V_{IN}$ = 0 V or $V_{CC}$ | 11<br>12.5 | pF   |

5.  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:  $I_{CC(OPR)} = C_{PD} \cdot V_{CC} \cdot f_{in}$ )  $I_{CC}$ .  $C_{PD}$  is used to determine the no–load dynamic power consumption;  $P_D = C_{PD} \cdot V_{CC}^2 \cdot f_{in}$ )  $I_{CC} \cdot V_{CC}$ .

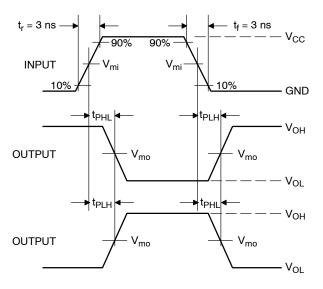


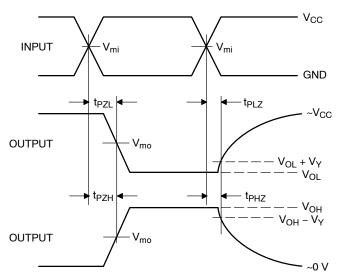
| Test                                | Switch<br>Position | C <sub>L</sub> , pF          | $R_{L}, \Omega$ | $R_1, \Omega$ |  |  |
|-------------------------------------|--------------------|------------------------------|-----------------|---------------|--|--|
| t <sub>PLH</sub> / t <sub>PHL</sub> | Open               | See AC Characteristics Table |                 |               |  |  |
| t <sub>PLZ</sub> / t <sub>PZL</sub> | $2 \times V_{CC}$  | 50                           | 500             | 500           |  |  |
| t <sub>PHZ</sub> / t <sub>PZH</sub> | GND                | 50                           | 500             | 500           |  |  |
| V D HO                              |                    |                              |                 |               |  |  |

X = Don't Care

 $C_L$  includes probe and jig capacitance  $R_T$  is  $Z_{OUT}$  of pulse generator (typically 50  $\Omega)$  f = 1 MHz

### Figure 3. Test Circuit





### Figure 4. Switching Waveforms

|                     |                     | Vm                                  |   |                    |
|---------------------|---------------------|-------------------------------------|---|--------------------|
| V <sub>CC</sub> , V | V <sub>mi</sub> , V | t <sub>PLH</sub> , t <sub>PHL</sub> | t <sub>PZL</sub> , t <sub>PLZ</sub> , t <sub>PZH</sub> , t <sub>PHZ</sub> | V <sub>Y</sub> , V |
| 1.65 to 1.95        | V <sub>CC</sub> /2  | V <sub>CC</sub> /2                  | V <sub>CC</sub> / 2   | 0.15               |
| 2.3 to 2.7          | V <sub>CC</sub> /2  | V <sub>CC</sub> /2                  | V <sub>CC</sub> / 2   | 0.15               |
| 3.0 to 3.6          | V <sub>CC</sub> /2  | V <sub>CC</sub> /2                  | V <sub>CC</sub> / 2   | 0.3                |
| 4.5 to 5.5          | V <sub>CC</sub> /2  | V <sub>CC</sub> /2                  | V <sub>CC</sub> / 2   | 0.3                |

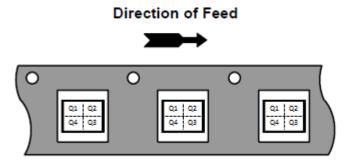
# **ORDERING INFORMATION**

| Device           | Package                 | Specific Device Code   | Pin1 Orientation<br>(See bellow) | Shipping <sup>†</sup> |
|------------------|-------------------------|------------------------|----------------------------------|-----------------------|
| NL27WZ16DFT2G    | SC-88                   | MR                     | Q4                               | 3000 / Tape & Reel    |
| NL27WZ16DFT2G-Q* | SC-88                   | MR                     | Q4                               | 3000 / Tape & Reel    |
| NL27WZ16DBVT1G   | SC-74                   | MR                     | Q4                               | 3000 / Tape & Reel    |
| NL27WZ16MU1TCG   | UDFN6, 1.45 x 1.0, 0.5P | F<br>(Rotated 90° CW)  | Q4                               | 3000 / Tape & Reel    |
| NL27WZ16MU3TCG   | UDFN6, 1.0 x 1.0, 0.35P | T<br>(Rotated 90° CW)  | Q4                               | 3000 / Tape & Reel    |
| NL27WZ16MU2TCG   | UDFN6, 1.2 x 1.0, 0.4P  | 5<br>(Rotated 180° CW) | Q4                               | 3000 / Tape & Reel    |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*–Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable.

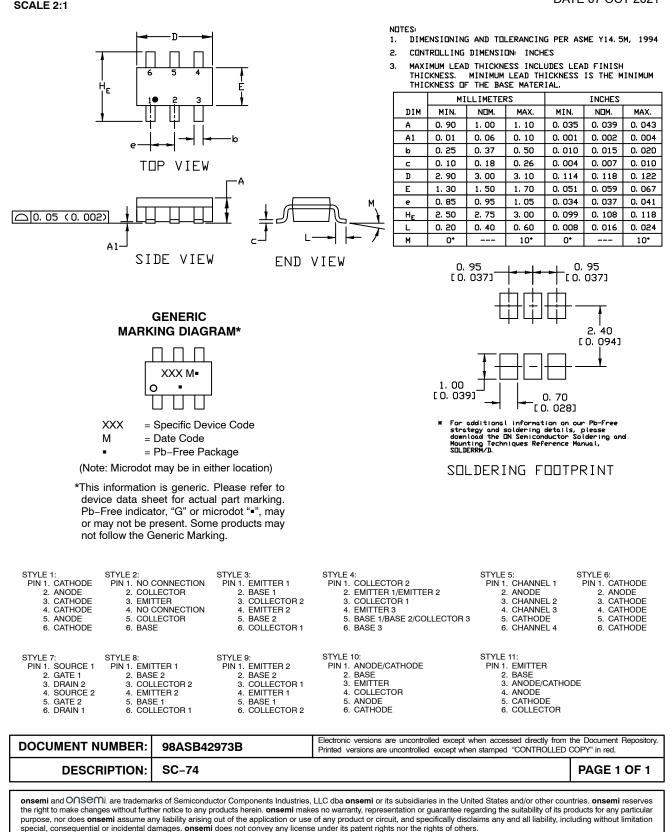
# Pin 1 Orientation in Tape and Reel



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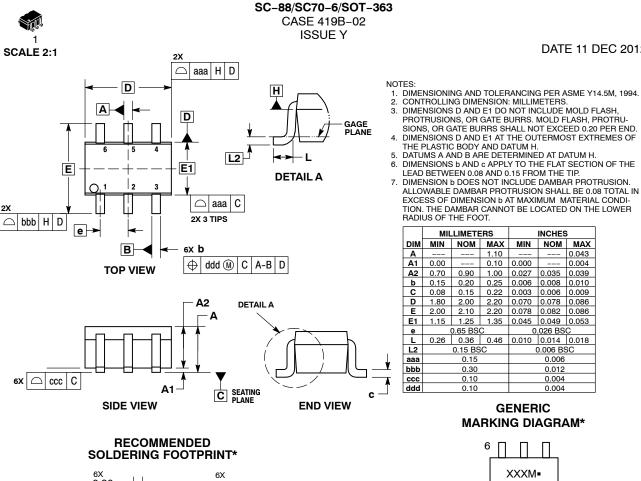
SC-74 CASE 318F ISSUE P

DATE 07 OCT 2021



# **NSEM**

DATE 11 DEC 2012



6X 0.30 0.66 2 50 0.65 PITCH DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION 6 AT MAXIMUM MATERIAL CONDI-TION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER **BADIUS OF THE FOOT.** 

|     | MIL      | LIMETE  | RS   |           | INCHES   | ;     |
|-----|----------|---------|------|-----------|----------|-------|
| DIM | MIN      | NOM     | MAX  | MIN       | NOM      | MAX   |
| Α   |          |         | 1.10 |           |          | 0.043 |
| A1  | 0.00     |         | 0.10 | 0.000     |          | 0.004 |
| A2  | 0.70     | 0.90    | 1.00 | 0.027     | 0.035    | 0.039 |
| b   | 0.15     | 0.20    | 0.25 | 0.006     | 0.008    | 0.010 |
| С   | 0.08     | 0.15    | 0.22 | 0.003     | 0.006    | 0.009 |
| D   | 1.80     | 2.00    | 2.20 | 0.070     | 0.078    | 0.086 |
| Е   | 2.00     | 2.10    | 2.20 | 0.078     | 0.082    | 0.086 |
| E1  | 1.15     | 1.25    | 1.35 | 0.045     | 0.049    | 0.053 |
| е   |          | 0.65 BS | С    | 0.026 BSC |          |       |
| L   | 0.26     | 0.36    | 0.46 | 0.010     | 0.014    | 0.018 |
| L2  | 0.15 BSC |         |      | (         | 0.006 BS | SC    |
| aaa | 0.15     |         |      | 0.006     |          |       |
| bbb | 0.30     |         |      | 0.012     |          |       |
| ccc |          | 0.10    |      | 0.004     |          |       |
| ddd |          | 0.10    |      |           | 0.004    |       |

#### GENERIC **MARKING DIAGRAM\***



XXX = Specific Device Code

- Μ = Date Code\*
- = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

# **STYLES ON PAGE 2**

| DOCUMENT NUMBER:  | 98ASB42985B   | Electronic versions are uncontrolled except when accessed directly from the Document Repository.<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.   |                            |
|---|---|---|----------------------------|
| DESCRIPTION:  | SC-88/SC70-6/SOT-363  |   | PAGE 1 OF 2                |
| the right to make changes without furth<br>purpose, nor does <b>onsemi</b> assume a | ner notice to any products herein. <b>onsemi</b> make<br>ny liability arising out of the application or use | LLC dba <b>onsemi</b> or its subsidiaries in the United States and/or other cours no warranty, representation or guarantee regarding the suitability of its pr of any product or circuit, and specifically disclaims any and all liability, inc e under its patent rights nor the rights of others. | roducts for any particular |

### SC-88/SC70-6/SOT-363 CASE 419B-02 ISSUE Y

# DATE 11 DEC 2012

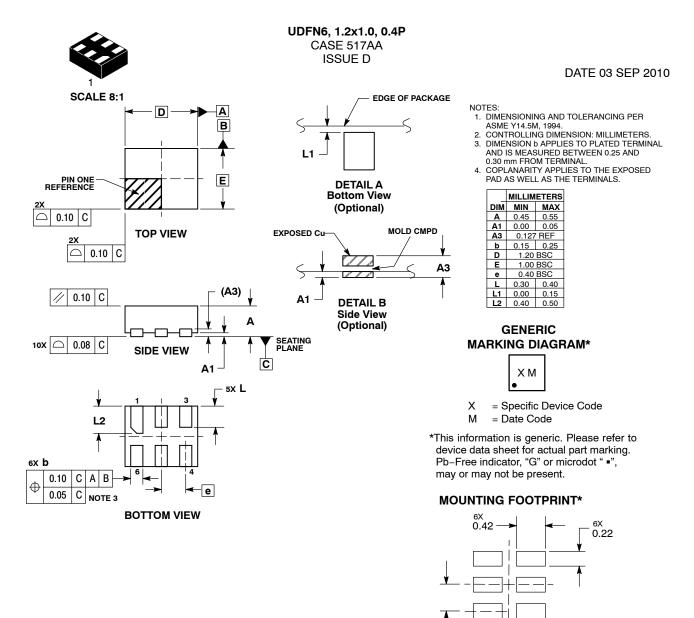
| STYLE 1:<br>PIN 1. EMITTER 2<br>2. BASE 2<br>3. COLLECTOR 1<br>4. EMITTER 1<br>5. BASE 1<br>6. COLLECTOR 2 | STYLE 2:<br>CANCELLED | STYLE 3:<br>CANCELLED  | STYLE 4:<br>PIN 1. CATHODE<br>2. CATHODE<br>3. COLLECTOR<br>4. EMITTER<br>5. BASE<br>6. ANODE     | STYLE 5:<br>PIN 1. ANODE<br>2. ANODE<br>3. COLLECTOR<br>4. EMITTER<br>5. BASE<br>6. CATHODE               | STYLE 6:<br>PIN 1. ANODE 2<br>2. N/C<br>3. CATHODE 1<br>4. ANODE 1<br>5. N/C<br>6. CATHODE 2          |
|--|-----------------------|--|---|---|---|
| STYLE 7:<br>PIN 1. SOURCE 2<br>2. DRAIN 2<br>3. GATE 1<br>4. SOURCE 1<br>5. DRAIN 1<br>6. GATE 2           | STYLE 8:<br>CANCELLED | STYLE 9:<br>PIN 1. EMITTER 2<br>2. EMITTER 1<br>3. COLLECTOR 1<br>4. BASE 1<br>5. BASE 2<br>6. COLLECTOR 2 | STYLE 10:<br>PIN 1. SOURCE 2<br>2. SOURCE 1<br>3. GATE 1<br>4. DRAIN 1<br>5. DRAIN 2<br>6. GATE 2 | STYLE 11:<br>PIN 1. CATHODE 2<br>2. CATHODE 2<br>3. ANODE 1<br>4. CATHODE 1<br>5. CATHODE 1<br>6. ANODE 2 | STYLE 12:<br>PIN 1. ANODE 2<br>2. ANODE 2<br>3. CATHODE 1<br>4. ANODE 1<br>5. ANODE 1<br>6. CATHODE 2 |
| STYLE 13:  | STYLE 14:             | STYLE 15:  | STYLE 16:   | STYLE 17:   | STYLE 18:   |
| PIN 1. ANODE   | PIN 1. VREF           | PIN 1. ANODE 1   | PIN 1. BASE 1   | PIN 1. BASE 1   | PIN 1. VIN1   |
| 2. N/C   | 2. GND                | 2. ANODE 2   | 2. EMITTER 2  | 2. EMITTER 1  | 2. VCC  |
| 3. COLLECTOR   | 3. GND                | 3. ANODE 3   | 3. COLLECTOR 2  | 3. COLLECTOR 2  | 3. VOUT2  |
| 4. EMITTER   | 4. IOUT               | 4. CATHODE 3   | 4. BASE 2   | 4. BASE 2   | 4. VIN2   |
| 5. BASE  | 5. VEN                | 5. CATHODE 2   | 5. EMITTER 1  | 5. EMITTER 2  | 5. GND  |
| 6. CATHODE   | 6. VCC                | 6. CATHODE 1   | 6. COLLECTOR 1  | 6. COLLECTOR 1  | 6. VOUT1  |
| STYLE 19:  | STYLE 20:             | STYLE 21:  | STYLE 22:   | STYLE 23:   | STYLE 24:   |
| PIN 1. I OUT   | PIN 1. COLLECTOR      | PIN 1. ANODE 1   | PIN 1. D1 (i)   | PIN 1. Vn   | PIN 1. CATHODE  |
| 2. GND   | 2. COLLECTOR          | 2. N/C   | 2. GND  | 2. CH1  | 2. ANODE  |
| 3. GND   | 3. BASE               | 3. ANODE 2   | 3. D2 (i)   | 3. Vp   | 3. CATHODE  |
| 4. V CC  | 4. EMITTER            | 4. CATHODE 2   | 4. D2 (c)   | 4. N/C  | 4. CATHODE  |
| 5. V EN  | 5. COLLECTOR          | 5. N/C   | 5. VBUS   | 5. CH2  | 5. CATHODE  |
| 6. V REF   | 6. COLLECTOR          | 6. CATHODE 1   | 6. D1 (c)   | 6. N/C  | 6. CATHODE  |
| STYLE 25:  | STYLE 26:             | STYLE 27:  | STYLE 28:   | STYLE 29:   | STYLE 30:   |
| PIN 1. BASE 1  | PIN 1. SOURCE 1       | PIN 1. BASE 2  | PIN 1. DRAIN  | PIN 1. ANODE  | PIN 1. SOURCE 1   |
| 2. CATHODE   | 2. GATE 1             | 2. BASE 1  | 2. DRAIN  | 2. ANODE  | 2. DRAIN 2  |
| 3. COLLECTOR 2   | 3. DRAIN 2            | 3. COLLECTOR 1   | 3. GATE   | 3. COLLECTOR  | 3. DRAIN 2  |
| 4. BASE 2  | 4. SOURCE 2           | 4. EMITTER 1   | 4. SOURCE   | 4. EMITTER  | 4. SOURCE 2   |
| 5. EMITTER   | 5. GATE 2             | 5. EMITTER 2   | 5. DRAIN  | 5. BASE/ANODE   | 5. GATE 1   |
| 6. COLLECTOR 1   | 6. DRAIN 1            | 6. COLLECTOR 2   | 6. DRAIN  | 6. CATHODE  | 6. DRAIN 1  |

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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DIMENSIONS: MILLIMETERS

1.07

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0.40

PITCH

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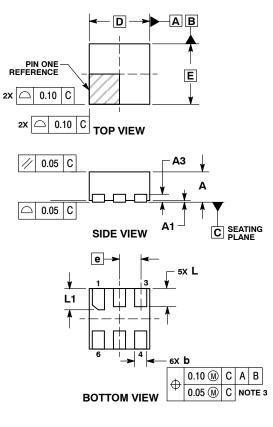
- X = Specific Device Code
- M = Date Code
- \*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

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# DUSem



SCALE 4:1



UDFN6, 1x1, 0.35P CASE 517BX **ISSUE O** 

#### DATE 18 MAY 2011

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN A DE ADD & OR MULTICAL TERMINAL TR
- AND 0.20 MM FROM TERMINAL TIP.
   PACKAGE DIMENSIONS EXCLUSIVE OF BURRS AND MOLD FLASH.

| BURRS AND MOLD FL |             |      |  |  |
|-------------------|-------------|------|--|--|
|                   | MILLIMETERS |      |  |  |
| DIM               | MIN         | MAX  |  |  |
| Α                 | 0.45        | 0.55 |  |  |
| A1                | 0.00 0.05   |      |  |  |
| A3                | 0.13 REF    |      |  |  |
| b                 | 0.12        | 0.22 |  |  |
| D                 | 1.00 BSC    |      |  |  |
| E                 | 1.00 BSC    |      |  |  |
| е                 | 0.35 BSC    |      |  |  |
| L                 | 0.25        | 0.35 |  |  |
| L1                | 0.30        | 0.40 |  |  |

#### RECOMMENDED **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### GENERIC **MARKING DIAGRAM\***



X = Specific Device Code M = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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